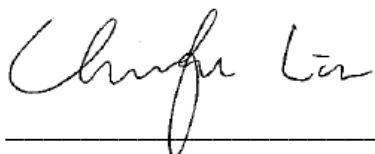


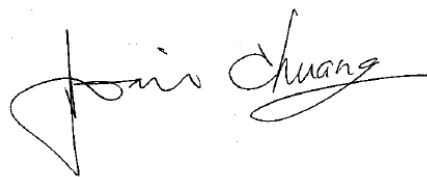
## Harvatek Surface Mount CHIP LEDs Approval Sheet

Model No.: HT-E374FCH

**Acknowledged by**



**Section Manager**  
**Production Engineering Dept.**



**Manager**  
**Production Engineering Dept.**

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Tentative Product	*****	*****		HDS-E374-K175
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### Introduction

- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by HARVATEK for any infringements of intellectual properties or other rights of the third parties which may result from their use.
- Harvatek is continually improving the quality of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing HARVATEK products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such HARATEK products can cause loss of human life, bodily injury or damage to property.
- The HARVATEK products listed in this document are intended for usage in general electronics (computer, personal equipment, office equipment, industrial robotics, domestic, etc...). These products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability.
- In developing your designs, please ensure that HARVATEK products are used within the specified operating ranges as set forth in the most recent HARVATEK products specifications.
- Also, please keep in mind the precautions listed in this document.

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### Product Specification

	Specification	Material	Quantity
Iv	Red:100-220mcd Green:100-285mcd Blue:50-112mcd @20mA/ Ta= 25° C		
lambda	Red: 615-635 nm Green: 515-535 nm Blue: 465-480 nm @20mA/ Ta=25° C		
Vf	Red: 1.8-2.3V Green: 2.7-3.7V Blue: 2.7-3.7V @20mA/ Ta=25° C Tolerance±0.05V		
Ir	HT standard		
Resin	Milky Diffused	Epoxy resin	
Carrier tape	According to EIA 481-1A specs	Conductive Black tape	2000pcs per reel
Reel	According to EIA 481-1A specs	Conductive Black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel one bag
Carton	HT standard	Paper	Non-specified

Others:

**ATTENTION: Electricstatic Discharge (ESD) protection**




The symbol shown on the page herein to introduce 'Electro-Optical Characteristics'. ESD protection for GaP and AlGaAs based chips is still necessary even though they are safe in low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are

**STATIC SENSITIVE devices.** ESD protection has to considered and taken in the initial design stage. If manual work/process is needed, please ensure the device is well protected from ESD during all the process.

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Label Spec.:

<b>HARVATEK</b>		Date: yyyy/mm/dd 
CUSTOMER P/N: 		
HARVATEK P/N: 	QTY: PCS 	
LOT NO: 		QC
IV BIN: COLOR BIN: VF:		

■ Customer P/N: To Be Defined

■ Harvatek P/N

**H T - E 3 7 4 F C H**



Series Name	Emitting Color
HT-E374: 2.0x1.3x0.5mm	Full Color: Red, Green and Blue

■ Lot No.

1 2 3 4 5 6 7 8 9 10  
**P 1 2 2 3 0 A - D T**

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
Internal Tracing Code	Z: 2000 1: 2001 2: 2002 3: 2003 .....	1: Jan. 2: Feb. .... 9: Sep. A: Oct. B: Nov. C: Dec.	1~31/ (30)	01~99, A,B,C...	D: Milky White	T: Taped Reel

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### ■ Iv Bin: Red / Green / Blue

Color	Bin Code	Spec. Range
Red	R	100-220mcd
Green	R	100-180mcd
	S	180-285mcd
Blue	Q	50-112mcd

### ■ Color Bin: Red / Green / Blue

Color	Bin Code	Spec. Range
Red	-	615-635nm
Green	G	515-525nm
	H	525-535nm
Blue	B	465-470nm
	C	470-475nm
	D	475-480nm

### ■ Vf Bin: Red / Green / Blue

Color	Bin Code	Spec. Range
Red	-	1.8-2.3V
Green	G45	2.7-3.2V
	J15	3.2-3.7V
Blue	G45	2.7-3.2V
	J15	3.2-3.7V

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### Product Feature

#### ■ Electro-Optical Characteristics

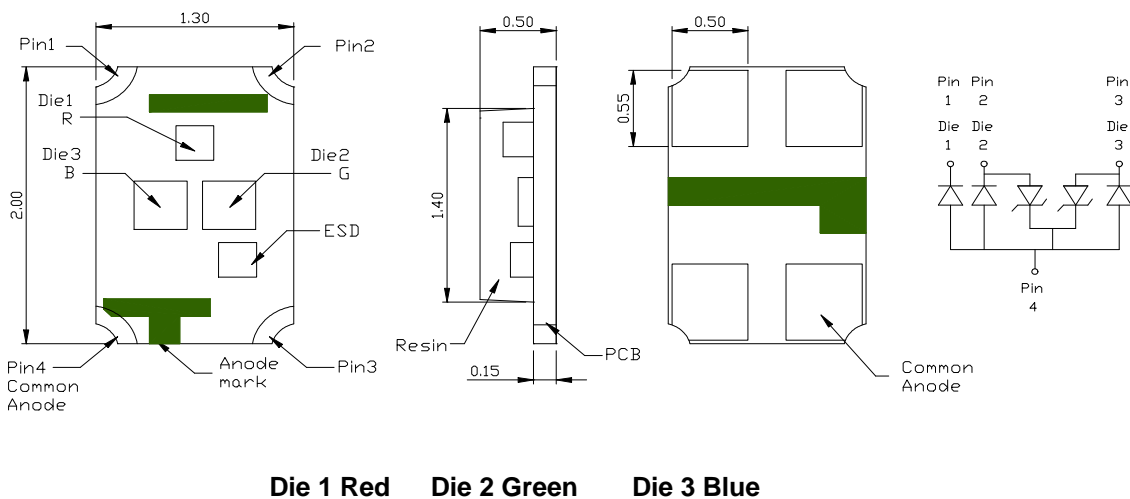
( $I_F$  @ 20mA,  $T_a$  25°C)

Code for parts	Lighting Color			$V_F$ (V)		$\lambda$ (nm)			$I_V$ (mcd)	
				typ	max	$\lambda_D$	$\lambda_P$	$\Delta\lambda$	Min	Typ.
HT-E374FCH	Die1	Ultra Bright Red	USD	2.0	2.3	622	636	17	100	120
	Die2	Green	NG	3.3	3.7	527	520	40	100	160
	Die3	Blue	NB	3.3	3.7	470	468	40	50	80

#### ■ Package Outline Dimension and Recommended Soldering Pattern for Re-flow Soldering

Tolerance: +/-0.05

#### Outline Dim.



1. Soldering terminal may shift in x, y direction.
2. Common anode.

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### Absolute Maximum Ratings

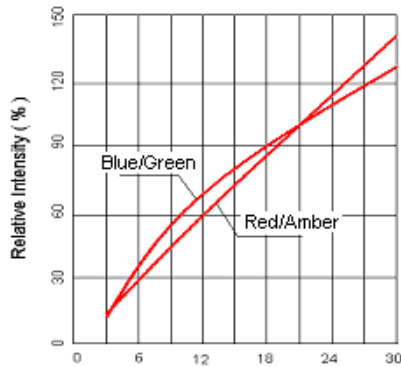
( $T_a$  25 °C)

Series	$P_d$ (mW)	$I_F$ (mA)	$I_{FP}$ (mA)	$V_R$ (V)	$I_R$ (uA)	$T_{OP}$ (°C)	$T_{ST}$ (°C)
Red	46	20	80**	5	<100@ $V_R = 5$	-30~+80	-40~+85
Blue / Green	55	15	60**				

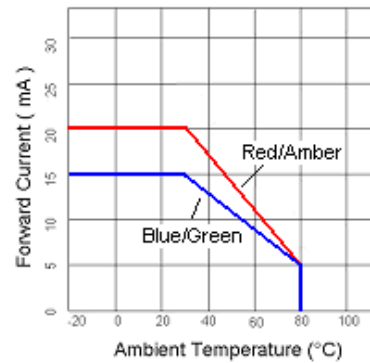
\*\* Condition for  $I_{FP}$  is pulse of 1/10 duty and 0.1msec width

### Characteristics of HT-E374FCH Series

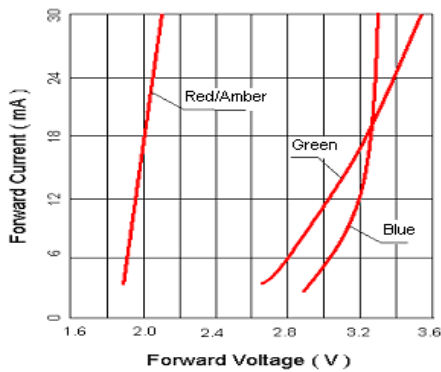
Relative Intensity vs. Forward Current



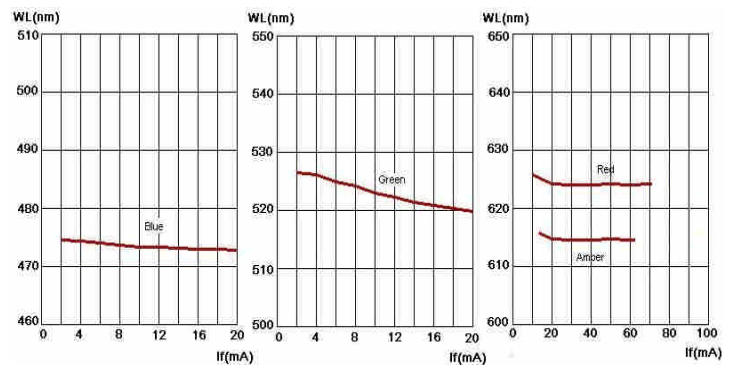
Forward Current vs. Ambient Temperature



Forward Voltage vs. Forward Current



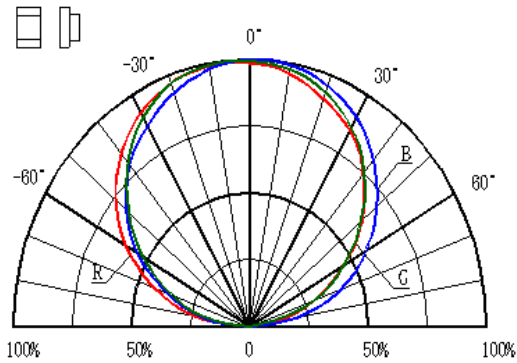
Wavelength vs. Forward Current



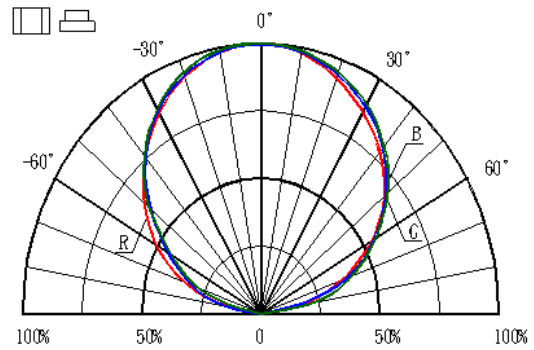
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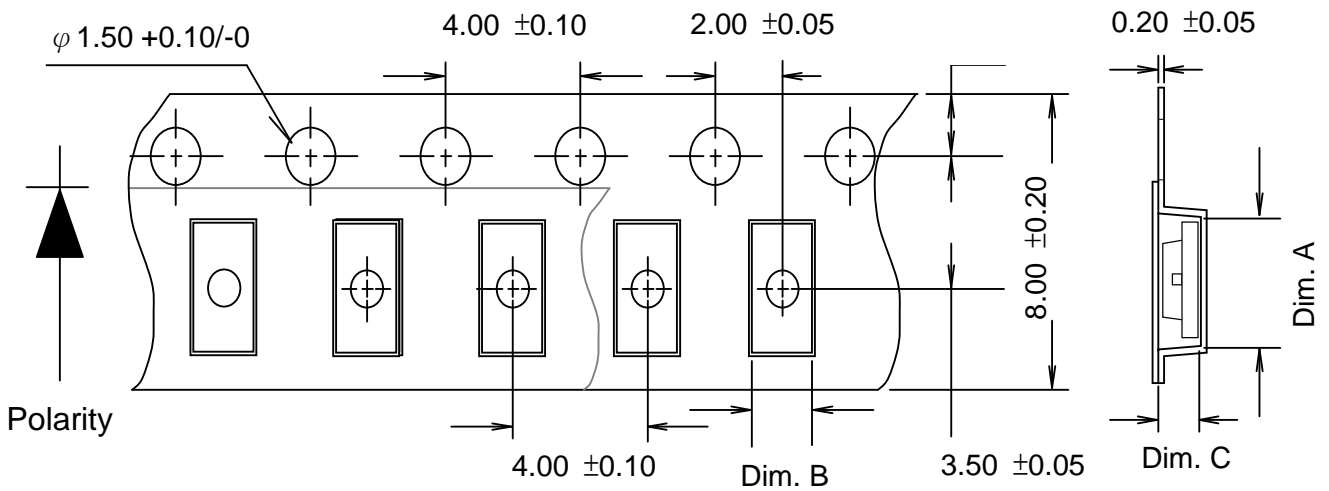
Directive Characteristics



Directive Characteristics



### Tape Dimension

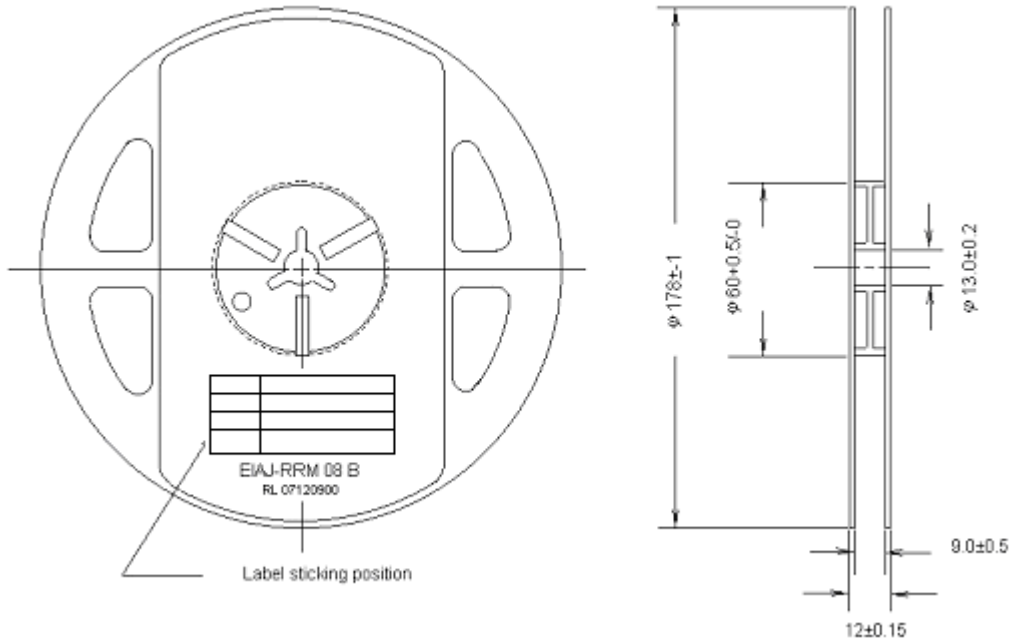


Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-E374	$2.24 \pm 0.10$	$1.37 \pm 0.10$	$0.74 \pm 0.10$	2K

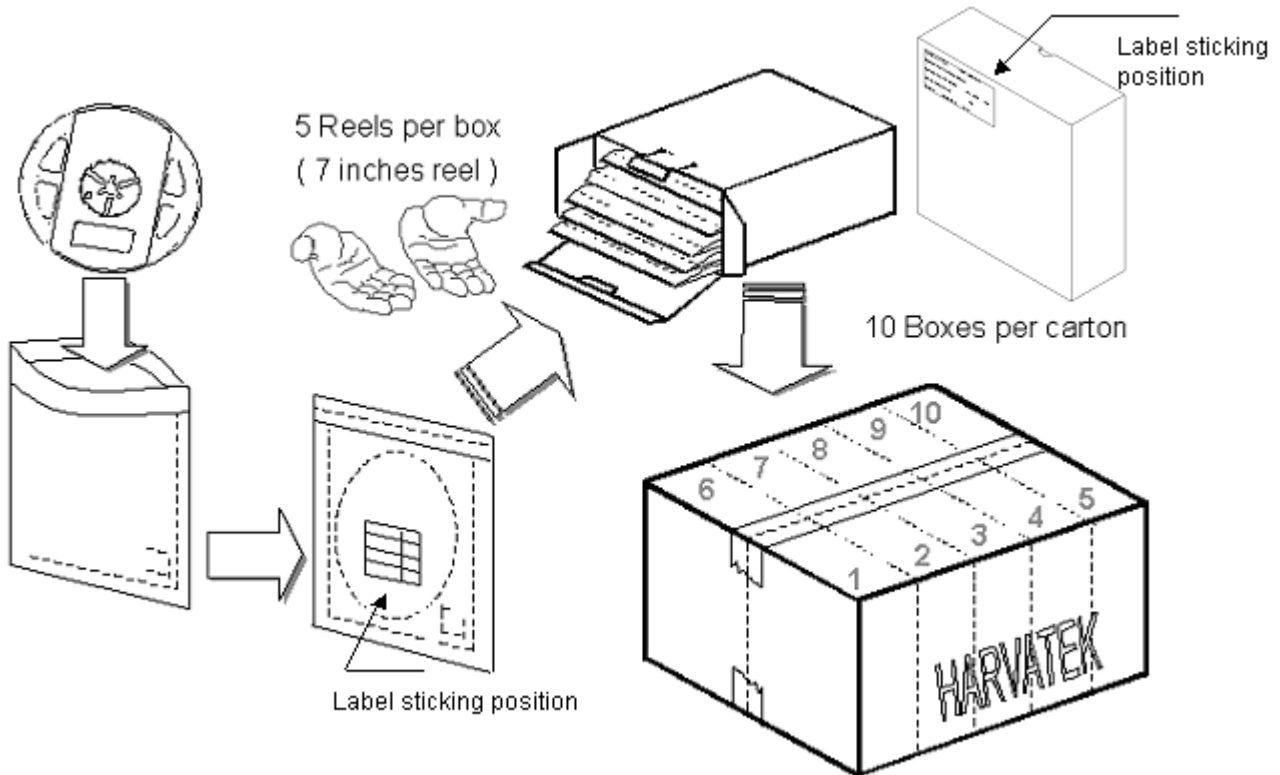
Unit: mm

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### Reel Dimension



### Packing model



5 boxes per carton is available according to shipping quantity.

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## Precaution of Application

### Designing 1: Soldering pattern

The dimensions of the recommended soldering pattern may not meet every user. Please confirm and study first before designing the soldering pattern in order to obtain the best performance of soldering.

### Designing 2: Circuit layout

Due to the circuit design is not available, assuming the LED are used in parallel and one resistor that is put in series in the circuit, it may not provide an effective current-limiting function to the LEDs due to each LED has own inherent resistance, maybe the resistance each other is different. Different inherent resistance will cause different current; the LED on the different path would be driven at different power. If one LED with a higher resistance, it would be dimmer than the others.

To solve this situation, a suitable resistor is put in series with each LED to limit the current disparity through the LED will be very useful.

### Designing 3: Electric Static Discharge (ESD) protection



ESD protection for GaP and AlGaAs chips are still necessary even though they are safety in low static-electric discharge. Material in AlInGaP, GaN, or/and InGaN chips are **STATIC SENSITIVE device**. ESD protection shall be considered and taken in the initial design stage.

If manual work/process is needed, please ensure the device is well protective from ESD within all the process.

### Designing 4: Max Rating

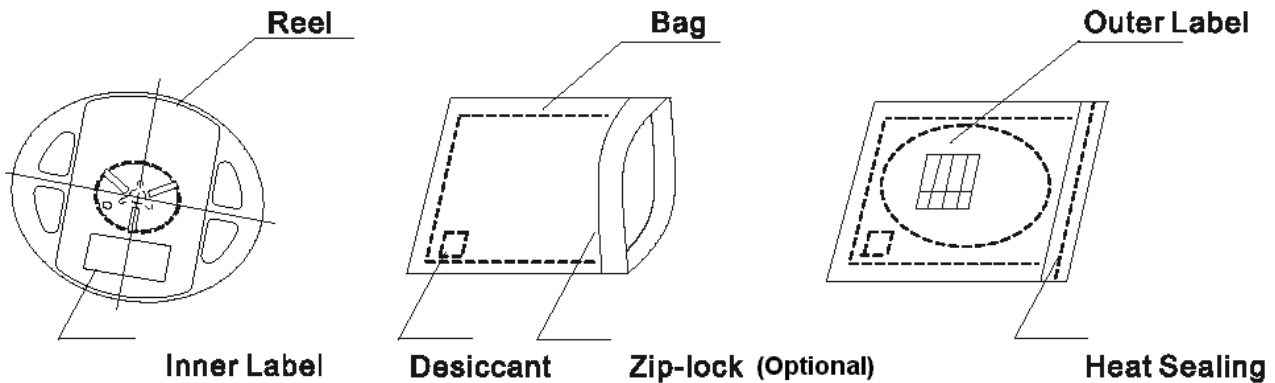
Any application should refer to the specifications of absolute maximum ratings.

### Dry Pack

Any SMD optical device, like this chip LED, is **MOISTURE SENSITIVE device**. Avoid absorbing moisture at any time during transportation or storage. Every reel will be packaged in the moisture barrier anti-static bag (Specific bag material will depend upon customers' requirement or option). And the bag is well sealed before shipment.

The package is the following:

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### Storage

It's recommended to store the products in the following conditions:

Humidity: 60 %RH Max.

Temperature: 5 °C ~30 °C (41°F~86 °F)

- 1 Shelf life in sealed bag: 12 month at <math>40^{\circ}\text{C}</math> and <math>90\% \text{RH}</math>. (Base on aluminum laminated moisture barrier bag.)
- 2 After the bag is opened, devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing must be:
  - 2.1 Mounted within 72 hours at factory conditions of  $\leq 30^{\circ}\text{C} / 60\% \text{RH}$ , or
  - 2.2 Stored at  $\leq 20\% \text{RH}$  with zip-lock sealed.

### Baking

It's recommended to bake before soldering when the pack is unsealed after 15 days. The conditions are as followings:

- a)  $60 \pm 3^{\circ}\text{C} \times (12 \sim 24 \text{hrs})$  and <math>5\% \text{RH}</math>, taped reel type
- b)  $100 \pm 3^{\circ}\text{C} \times (45 \text{min} \sim 1 \text{hr})$ , bulk type
- c)  $130 \pm 3^{\circ}\text{C} \times (15 \sim 30 \text{min})$ , bulk type

### Soldering

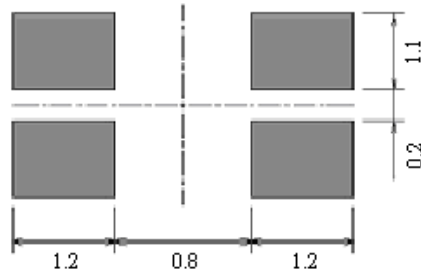
Manual soldering (We do not recommend this method strongly.)

- ◆ Soldering tin material: tin 6/4 alloy or contained Ag.
- ◆ To prevent cracking, please bake before manual soldering.
- ◆ Keep the temperature on the edge of iron at  $300^{\circ}\text{C} \pm 5^{\circ}\text{C}$  max. (25W) and apply for 3 seconds. If the temperature become higher, apply in a shorter time (1 sec. per  $10^{\circ}\text{C}$ )
- ◆ In manual soldering, take care not to damage the package especially terminal or resin. (Do not give stress to the product when soldering)

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- ◆ Do not use again if you remove the soldered product.
- ◆ It is recommended using an iron with a temperature control.

### Soldering Pattern

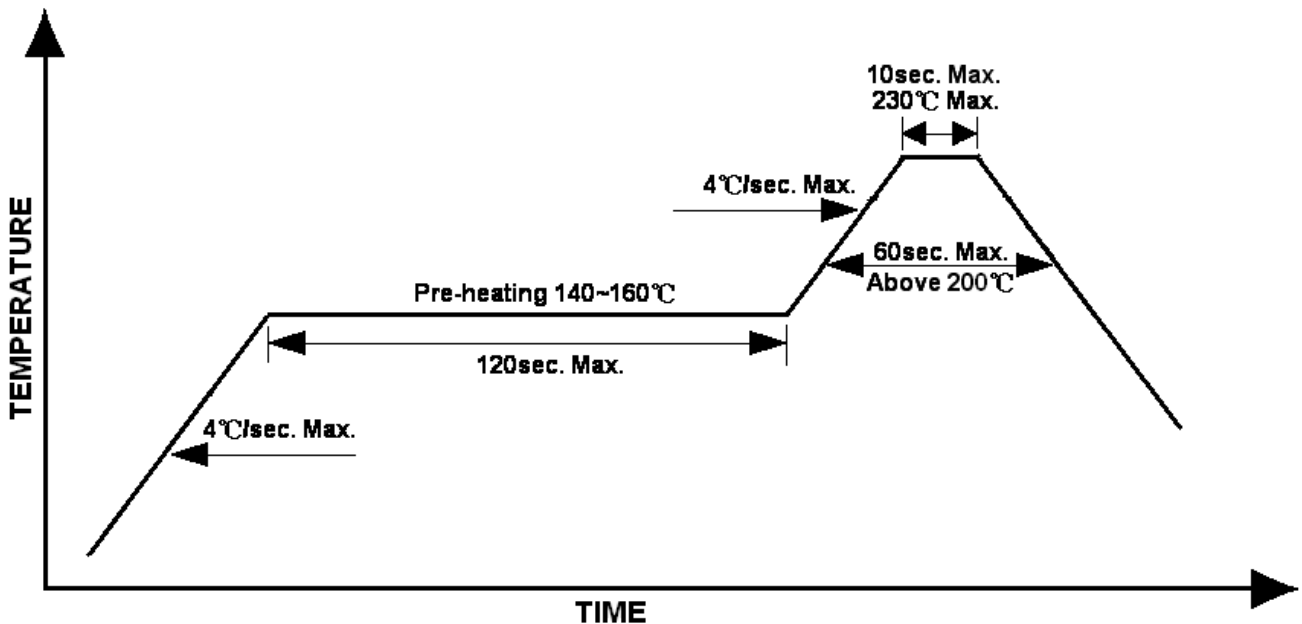


Unit: mm

### Re-flow Soldering

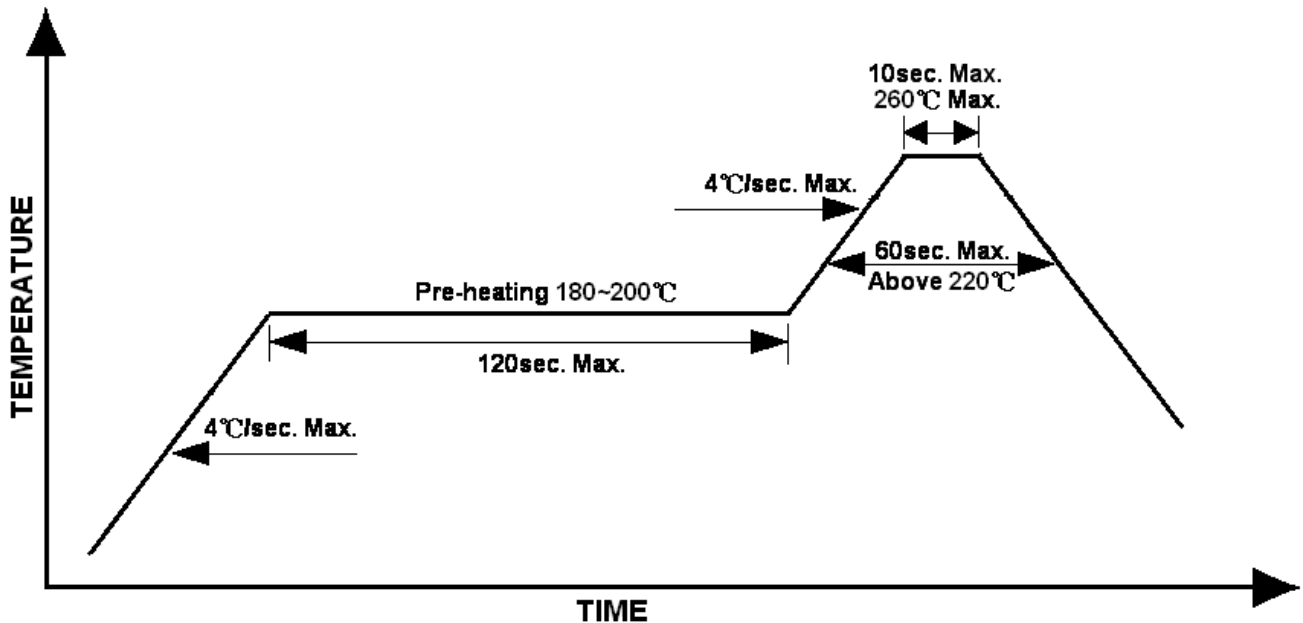
- ◆ Recommend tin glue specifications:  
Melting temperature: 178~192 °C
- ◆ Never take next process until the component is cooled down to room temperature after re-flow.
- ◆ The recommended reflow soldering profile (measuring on the surface of the LED resin) is following:

### Lead Solder profile



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## Lead-free Solder profile



## Rework

- ◆ Customer must finish rework within 5 sec. under 260 °C.
- ◆ The head of iron cannot touch copper foil.
- ◆ Twin-head type is preferred.

## Cleaning

- ◆ The conditions of cleaning after soldering:
- ◆ An alcohol-based solvent such as Isopropyl Alcohol (IPA) is recommended.
- ◆ Temperature×Time: <50 °C×30sec, or <30 °C×3min
- ◆ Ultra sonic cleaning: < 15W/ bath; Bath volume: 1liter max.
- ◆ Curing: 100 °C max, <3min

## Cautions of Pick and Place

- ◆ It should be avoided to load stress on the resin during high temperature.
- ◆ Avoid rubbing or scraping the resin by any object.
- ◆ Electric-static may cause damage to the component. Please confirm that the equipment is grounding well. Using an ionizer fan is recommended.

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### Reliability Test

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5±0.5cm/s Tinning: A: 215°C/ 3±1s or B: 260°C/ 10±1s
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260±/-5°C; 10±/-1s B: 350±/-10°C; 3±/-0.5s
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) T <sub>amb</sub> 25°C; I <sub>F</sub> =20mA; duration 1000hrs
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	T <sub>amb</sub> : 85°C Humidity: 85% R.H., I <sub>F</sub> =5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20/ 0	HT specs.	T <sub>amb</sub> : 55°C I <sub>F</sub> =20mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		T <sub>amb</sub> 25°C, I <sub>F</sub> =20mA,, I <sub>p</sub> =100mA, Duty cycle=0.125 (tp=125 μs, T=1sec) Duration 500hrs)
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min.. 300 cycles 2 chamber/ Air-to-air type
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60±3°C 90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100±10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40±5°C for 500hrs

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